## Microchip Technology - PIC16F1823-I/P Datasheet

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### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	14-DIP (0.300", 7.62mm)
Supplier Device Package	14-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1823-i-p

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Name	FunctionInput TypeOutput Type		Output Type	Description		
A5/CLKIN/OSC1/T1OSI/T1CKI	RA5	TTL	CMOS	General purpose I/O.		
	CLKIN	CMOS	_	External clock input (EC mode).		
	OSC1	XTAL	_	Crystal/Resonator (LP, XT, HS modes).		
	T1OSI	XTAL	XTAL	Timer1 oscillator connection.		
	T1CKI	ST	_	Timer1 clock input.		
C0/AN4/CPS4/C2IN+/SCL/	RC0	TTL	CMOS	General purpose I/O.		
CK	AN4	AN	_	A/D Channel 4 input.		
	CPS4	AN	_	Capacitive sensing input 4.		
	C2IN+	AN		Comparator C2 positive input.		
	SCL	I <sup>2</sup> C™	OD	I <sup>2</sup> C <sup>™</sup> clock.		
	SCK	ST	CMOS	SPI clock.		
C1/AN5/CPS5/C12IN1-/SDA/	RC1	TTL	CMOS	General purpose I/O.		
DI	AN5	AN	_	A/D Channel 5 input.		
	CPS5	AN	_	Capacitive sensing input 5.		
	C12IN1-	AN		Comparator C1 or C2 negative input.		
	SDA	I <sup>2</sup> C™	OD	I <sup>2</sup> C <sup>™</sup> data input/output.		
	SDI	CMOS		SPI data input.		
C2/AN6/CPS6/C12IN2-/P1D/	RC2	TTL	CMOS	General purpose I/O.		
DO <sup>(1)</sup> /MDCIN1	AN6	AN		A/D Channel 6 input.		
	CPS6	AN	_	Capacitive sensing input 6.		
	C12IN2-	AN		Comparator C1 or C2 negative input.		
	P1D		CMOS	PWM output.		
	SDO	_	CMOS	SPI data output.		
	MDCIN1	ST		Modulator Carrier Input 1.		
C3/AN7/CPS7/C12IN3-/P1C/	RC6	TTL	CMOS	General purpose I/O.		
S <sup>(1)</sup> /MDMIN	AN7	AN		A/D Channel 6 input.		
	CPS7	AN	_	Capacitive sensing input 6.		
	C12IN3-	AN	_	Comparator C1 or C2 negative input.		
	P1C		CMOS	PWM output.		
	SS	ST		Slave Select input.		
	MDMIN	ST		Modulator source input.		
C4/C2OUT/SRNQ/P1B/CK(1)/	RC4	TTL	CMOS	General purpose I/O.		
X <sup>(1)</sup> /MDOUT	C2OUT	_	CMOS	Comparator C2 output.		
	SRNQ		CMOS	SR latch inverting output.		
	P1B		CMOS	PWM output.		
	СК	ST	CMOS	USART synchronous clock.		
	TX		CMOS	USART asynchronous transmit.		
	MDOUT		CMOS	Modulator output.		
C5/P1A/CCP1/DT <sup>(1)</sup> /RX <sup>(1)</sup> /	RC5	TTL	CMOS	General purpose I/O.		
IDCIN2	P1A		CMOS	PWM output.		
	CCP1	ST	CMOS	Capture/Compare/PWM 1.		
	DT	ST	CMOS	USART synchronous data.		
	RX	ST	—	USART asynchronous input.		
	MDCIN2	ST	_	Modulator Carrier Input 2.		

## TABLE 1-3: PIC16(L)F1823 PINOUT DESCRIPTION (CONTINUED)

Note 1: Pin functions can be assigned to one of two pin locations via software. See APFCON register (Register 12-1).

## FIGURE 3-1: PROGRAM MEMORY MAP AND STACK FOR PIC12(L)F1822/16(L)F1823

		_
	PC<14:0>	
CALL RETURN Interrup	· 13 .	
	• Stack Level 15	
	Reset Vector	0000h
	•	
	Interrupt Vector	0004h
On-chip Program Memory	Page 0	0005h 07FFh
	Rollover to Page 0	0800h
	:	
	Rollover to Page 0	7FFFh

## 3.1.1 READING PROGRAM MEMORY AS DATA

There are two methods of accessing constants in program memory. The first method is to use tables of RETLW instructions. The second method is to set an FSR to point to the program memory.

## 3.1.1.1 RETLW Instruction

The RETLW instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 3-1.

constants	
BRW	;Add Index in W to
	;program counter to
	;select data
RETLW DATA0	;Index0 data
RETLW DATA1	;Index1 data
RETLW DATA2	
RETLW DATA3	
my_function	
; LOTS OF CODE	
MOVLW DATA_IN	DEX
CALL constants	
; THE CONSTANT IS	IN W

The BRW instruction makes this type of table very simple to implement. If your code must remain portable with previous generations of microcontrollers, then the BRW instruction is not available so the older table read method must be used.

#### 3.2.1.1 STATUS Register

The STATUS register, shown in Register 3-1, contains:

- · the arithmetic status of the ALU
- · the Reset status

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The STATUS register can be the destination for any instruction, like any other register. If the STATUS register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the  $\overline{TO}$  and  $\overline{PD}$  bits are not writable. Therefore, the result of an instruction with the STATUS register as destination may be different than intended.

#### **REGISTER 3-1:** STATUS: STATUS REGISTER

For example, CLRF STATUS will clear the upper three bits and set the Z bit. This leaves the STATUS register as '000u uluu' (where u = unchanged).

It is recommended, therefore, that only BCF, BSF, SWAPF and MOVWF instructions are used to alter the STATUS register, because these instructions do not affect any Status bits. For other instructions not affecting any Status bits (Refer to Section 29.0 "Instruction Set Summary").

Note 1:	The C and DC bits operate as Borrow
	and Digit Borrow out bits, respectively, in
	subtraction.

U-0	U-0	U-0	R-1/q	R-1/q	R/W-0/u	R/W-0/u	R/W-0/u	
_	_	—	TO	PD	Z	DC <sup>(1)</sup>	C <sup>(1)</sup>	
bit 7							bit 0	
Legend:	Legend:							
R = Readable b	R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'							
u = Bit is uncha	u = Bit is unchanged x = Bit is unknown -n/n = Value at POR and BOR/Value at all other Reset					ther Resets		
'1' = Bit is set		'0' = Bit is clea	ared	q = Value depends on condition				

bit 7-5	Unimplemented: Read as '0'
bit 4	TO: Time-out bit
	1 = After power-up, CLRWDT instruction or SLEEP instruction 0 = A WDT time-out occurred
bit 3	PD: Power-down bit
	1 = After power-up or by the CLRWDT instruction 0 = By execution of the SLEEP instruction
bit 2	Z: Zero bit
	<ul> <li>1 = The result of an arithmetic or logic operation is zero</li> <li>0 = The result of an arithmetic or logic operation is not zero</li> </ul>
bit 1	DC: Digit Carry/Digit Borrow bit <sup>(1)</sup>
	<ul> <li>1 = A carry-out from the 4th low-order bit of the result occurred</li> <li>0 = No carry-out from the 4th low-order bit of the result</li> </ul>
bit 0	C: Carry/Borrow bit <sup>(1)</sup>
	<ul> <li>1 = A carry-out from the Most Significant bit of the result occurred</li> <li>0 = No carry-out from the Most Significant bit of the result occurred</li> </ul>
Note 1.	For Borrow, the polarity is reversed. A subtraction is executed by adding the two's complement of the

**Note 1:** For Borrow, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand.

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 4	Bank 4										
200h <sup>(1)</sup>	INDF0	Addressing th (not a physic		es contents of	FSR0H/FSR0	L to address	data memory	,		XXXX XXXX	XXXX XXXX
201h <sup>(1)</sup>	INDF1	Addressing th (not a physic		es contents of	FSR1H/FSR1	L to address	data memory	,		XXXX XXXX	XXXX XXXX
202h <sup>(1)</sup>	PCL	Program Cou	inter (PC) Lea	st Significant E	Byte					0000 0000	0000 0000
203h <sup>(1)</sup>	STATUS	_	_	_	TO	PD	Z	DC	С	1 1000	q quuu
204h <sup>(1)</sup>	FSR0L	Indirect Data	Memory Addr	ess 0 Low Poir	nter					0000 0000	uuuu uuuu
205h <sup>(1)</sup>	FSR0H	Indirect Data	Memory Addr	ess 0 High Poi	nter					0000 0000	0000 0000
206h <sup>(1)</sup>	FSR1L	Indirect Data	Memory Addr	ess 1 Low Poir	nter					0000 0000	uuuu uuuu
207h <sup>(1)</sup>	FSR1H	Indirect Data	Memory Addr	ess 1 High Poi	nter					0000 0000	0000 0000
208h <sup>(1)</sup>	BSR	_	_	_			BSR<4:0>			0 0000	0 0000
209h <sup>(1)</sup>	WREG	Working Reg	ister	•	•					0000 0000	uuuu uuuu
20Ah <sup>(1)</sup>	PCLATH	_	Write Buffer f	or the upper 7	bits of the Pro	ogram Counte	er			-000 0000	-000 0000
20Bh <sup>(1)</sup>	INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	0000 000x	0000 000u
20Ch	WPUA	_	—	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	11 1111	11 1111
20Dh	—	Unimplement	ted	•	•	•	•		•	_	_
20Eh	WPUC <sup>(2)</sup>	_	_	WPUC5	WPUC4	WPUC3	WPUC2	WPUC1	WPUC0	11 1111	11 1111
20Fh	—	Unimplement	ted	•					•	_	_
210h	_	Unimplement	ted							_	_
211h	SSP1BUF	Synchronous	Serial Port Re	eceive Buffer/T	ransmit Regis	ster				xxxx xxxx	uuuu uuuu
212h	SSP1ADD				ADD<	7:0>				0000 0000	0000 0000
213h	SSP1MSK				MSK<	7:0>				1111 1111	1111 1111
214h	SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	0000 0000	0000 0000
215h	SSP1CON1	WCOL	SSPOV	SSPEN	CKP		SSPN	//<3:0>		0000 0000	0000 0000
216h	SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
217h	SSP1CON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	0000 0000	0000 0000
218h	_	Unimplement	ted							_	_
219h	_	Unimplemented							_	_	
21Ah	_	Unimplemented							_	_	
21Bh	_	Unimplemented							_	_	
21Ch	_	Unimplement	Unimplemented								_
21Dh	_	Unimplement	Jnimplemented								_
21Eh	_	Unimplement	ted							_	_
21Fh	_	Unimplement	ted							_	—

## TABLE 3-8: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

**Legend:** x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

**Note 1:** These registers can be addressed from any bank.

2: PIC16(L)F1823 only.

**3:** Unimplemented. Read as '1'.

4: PIC12(L)F1822 only.

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R-1/q	R-0/q	R-q/q	R-0/q	R-0/q	R-q/q	R-0/0	R-0/q	
T1OSCR	PLLR	OSTS	HFIOFR	HFIOFL	MFIOFR	LFIOFR	HFIOFS	
bit 7							bit 0	
Legend:								
R = Readable		W = Writable		•	mented bit, read			
u = Bit is uncl	hanged	x = Bit is unk	nown	-n/n = Value a	at POR and BO	R/Value at all o	other Resets	
'1' = Bit is set		'0' = Bit is cle	ared	q = Condition	al			
bit 7	<u>If T1OSCEN</u> 1 = Timer1 0 = Timer1 <u>If T1OSCEN</u>	oscillator is rea	dy ready					
bit 6	<b>PLLR</b> 4x PL 1 = 4x PLL 0 = 4x PLL	L Ready bit is ready	ulways ready					
bit 5	1 = Runnin	llator Start-up T g from the clocl g from an interr	k defined by the	e FOSC<2:0> ł		guration Word	1	
bit 4	<ul> <li>HFIOFR: High Frequency Internal Oscillator Ready bit</li> <li>1 = HFINTOSC is ready</li> <li>0 = HFINTOSC is not ready</li> </ul>							
bit 3	1 = HFINTC	gh Frequency Ir DSC is at least 2 DSC is not 2% a	2% accurate	or Locked bit				
bit 2	1 = MFINTC	edium Frequend DSC is ready DSC is not read	-	illator Ready bi	it			
bit 1	1 = LFINTO	w Frequency In SC is ready SC is not ready		r Ready bit				
bit 0	1 = HFINTC	gh Frequency Ir DSC is at least ( DSC is not 0.5%	).5% accurate	or Stable bit				

## REGISTER 5-2: OSCSTAT: OSCILLATOR STATUS REGISTER

## EXAMPLE 11-2: DATA EEPROM WRITE

	MOVWF MOVLW MOVWF	DATA_EE_ADDR EEADRL DATA_EE_DATA EEDATL EECON1, CFGS	;Data Memory Address to write ; ;Data Memory Value to write ;Deselect Configuration space ;Point to DATA memory
Required Sequence	MOVLW MOVWF BSF BSF BCF	EECON2 OAAh EECON2 EECON1, WR INTCON, GIE	; ;Write 55h ; ;Write AAh ;Set WR bit to begin write ;Enable Interrupts ;Disable writes



	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
Flash ADDR	 {	PC + 1	EEADRH,EEADRL	PC + 3	PC + 4	PC + 5
Flash Data		STR (PC) INST	R (PC + 1) EEDA		R (PC + 3) INST	R (PC + 4)
	INSTR(PC - 1) executed here	BSF EECON1,RD executed here	INSTR(PC + 1) executed here	Forced NOP executed here	INSTR(PC + 3) executed here	INSTR(PC + 4) executed here
RD bit	 	 	/		 	
EEDATH EEDATL Register	 			Χ		
EERHLT	   	   			    	

### REGISTER 11-1: EEDATL: EEPROM DATA REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
			EEDA	T<7:0>			
bit 7							bit (
Legend:							
R = Readable bit		W = Writable bit		U = Unimpleme	nted bit, read as '0	,	
u = Bit is unchanged		x = Bit is unknown		-n/n = Value at F	OR and BOR/Valu	ue at all other Rese	ts
'1' = Bit is set		'0' = Bit is cleared					

bit 7-0

'1' = Bit is set

EEDAT<7:0>: Read/write value for EEPROM data byte or Least Significant bits of program memory

### REGISTER 11-2: EEDATH: EEPROM DATA HIGH BYTE REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—			EEDA	T<13:8>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6	Unimplemented: Read as '0'
DIL 7-0	Unimplementeu. Reau as 0

bit 5-0 EEDAT<13:8>: Read/write value for Most Significant bits of program memory

## REGISTER 11-3: EEADRL: EEPROM ADDRESS REGISTER

'0' = Bit is cleared

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
			EEAD	R<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit		W = Writable bit		U = Unimpleme	nted bit, read as '0	3	
u = Bit is unchange	ed	x = Bit is unknow	'n	-n/n = Value at F	POR and BOR/Valu	ue at all other Rese	ets

bit 7-0 EEADR<7:0>: Specifies the Least Significant bits for program memory address or EEPROM address

### **REGISTER 11-4: EEADRH: EEPROM ADDRESS HIGH BYTE REGISTER**

U-1	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
(1)				EEADR<14:8>			
bit 7							bit 0
Legend:							
R = Readable bit		W = Writable bit		U = Unimplemer	nted bit, read as '0	3	
u = Bit is unchange	ed	x = Bit is unknowr	ı	-n/n = Value at F	OR and BOR/Valu	ue at all other Res	ets
'1' = Bit is set		'0' = Bit is cleared					

bit 7 Unimplemented: Read as '1'

bit 6-0 **EEADR<14:8**>: Specifies the Most Significant bits for program memory address or EEPROM address

Note 1: Unimplemented, read as '1'.

## 19.7 Comparator Negative Input Selection

The CxNCH<1:0> bits of the CMxCON0 register direct one of four analog pins to the comparator inverting input.

Note:	To use CxIN+ and CxINx- pins as analog input, the appropriate bits must be set in the ANSEL register and the correspond-
	ing TRIS bits must also be set to disable the output drivers.

## 19.8 Comparator Response Time

The comparator output is indeterminate for a period of time after the change of an input source or the selection of a new reference voltage. This period is referred to as the response time. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response time to a comparator input change. See the Comparator and Voltage Reference Specifications in **Section 30.0 "Electrical Specifications"** for more details.

## **19.9** Interaction with ECCP Logic

The C1 and C2 comparators can be used as general purpose comparators. Their outputs can be brought out to the C1OUT and C2OUT pins. When the ECCP Auto-Shutdown is active it can use one or both comparator signals. If auto-restart is also enabled, the comparators can be configured as a closed loop analog feedback to the ECCP, thereby, creating an analog controlled PWM.

Note: When the Comparator module is first initialized the output state is unknown. Upon initialization, the user should verify the output state of the comparator prior to relying on the result, primarily when using the result in connection with other peripheral features, such as the ECCP Auto-Shutdown mode.

## 19.10 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 19-4. Since the analog input pins share their connection with a digital input, they have reverse biased ESD protection diodes to VDD and VSS. The analog input, therefore, must be between VSS and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up may occur.

A maximum source impedance of  $10 \text{ k}\Omega$  is recommended for the analog sources. Also, any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current to minimize inaccuracies introduced.

Note 1: When reading a PORT register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert as an analog input, according to the input specification.

2: Analog levels on any pin defined as a digital input, may cause the input buffer to consume more current than is specified.

#### 21.7 **Timer1 Interrupt**

The Timer1 register pair (TMR1H:TMR1L) increments to FFFFh and rolls over to 0000h. When Timer1 rolls over, the Timer1 interrupt flag bit of the PIR1 register is set. To enable the interrupt on rollover, you must set these bits:

- TMR1ON bit of the T1CON register
- TMR1IE bit of the PIE1 register
- · PEIE bit of the INTCON register
- · GIE bit of the INTCON register

The interrupt is cleared by clearing the TMR1IF bit in the Interrupt Service Routine.

The TMR1H:TMR1L register pair and the Note: TMR1IF bit should be cleared before enabling interrupts.

#### 21.8 **Timer1 Operation During Sleep**

Timer1 can only operate during Sleep when setup in Asynchronous Counter mode. In this mode, an external crystal or clock source can be used to increment the counter. To set up the timer to wake the device:

- TMR1ON bit of the T1CON register must be set
- TMR1IE bit of the PIE1 register must be set
- PEIE bit of the INTCON register must be set
- T1SYNC bit of the T1CON register must be set
- TMR1CS bits of the T1CON register must be configured
- T1OSCEN bit of the T1CON register must be configured

The device will wake-up on an overflow and execute the next instructions. If the GIE bit of the INTCON register is set, the device will call the Interrupt Service Routine.

Timer1 oscillator will continue to operate in Sleep regardless of the  $\overline{\text{T1SYNC}}$  bit setting.

#### 21.9 ECCP/CCP Capture/Compare Time Base

The CCP1 module uses the TMR1H:TMR1L register pair as the time base when operating in Capture or Compare mode.

In Capture mode, the value in the TMR1H:TMR1L register pair is copied into the CCPR1H:CCPR1L register pair on a configured event.

In Compare mode, an event is triggered when the value CCPR1H:CCPR1L register pair matches the value in the TMR1H:TMR1L register pair. This event can be a Special Event Trigger.

For more information, see Section 24.0 "Capture/Compare/PWM Modules".

## 21.10 ECCP/CCP Special Event Trigger

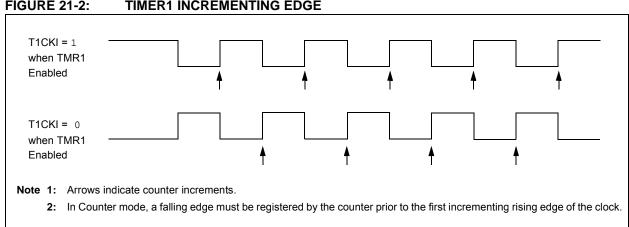
When any of the CCP's are configured to trigger a special event, the trigger will clear the TMR1H:TMR1L register pair. This special event does not cause a Timer1 interrupt. The CCP module may still be configured to generate a CCP interrupt.

In this mode of operation, the CCPR1H:CCPR1L register pair becomes the period register for Timer1.

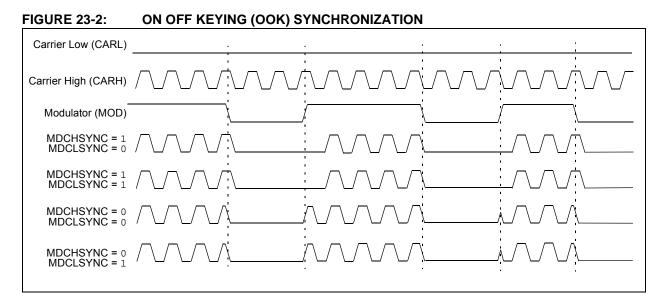
Timer1 should be synchronized and Fosc/4 should be selected as the clock source in order to utilize the Special Event Trigger. Asynchronous operation of Timer1 can cause a Special Event Trigger to be missed.

In the event that a write to TMR1H or TMR1L coincides with a Special Event Trigger from the CCP, the write will take precedence.

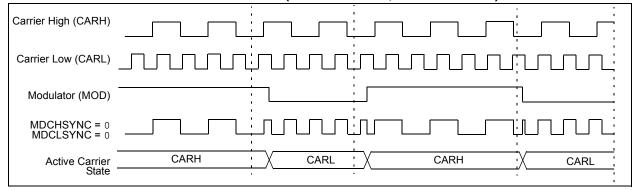
For more information, see Section 16.2.5 "Special Event Trigger".



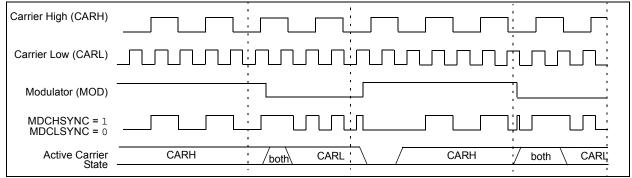
#### **FIGURE 21-2:** TIMER1 INCREMENTING EDGE



## EXAMPLE 23-1: NO SYNCHRONIZATION (MDSHSYNC = 0, MDCLSYNC = 0)



## FIGURE 23-3: CARRIER HIGH SYNCHRONIZATION (MDSHSYNC = 1, MDCLSYNC = 0)



## 25.0 MASTER SYNCHRONOUS SERIAL PORT MODULE

## 25.1 Master SSP (MSSP1) Module Overview

The Master Synchronous Serial Port (MSSP1) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be Serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP1 module can operate in one of two modes:

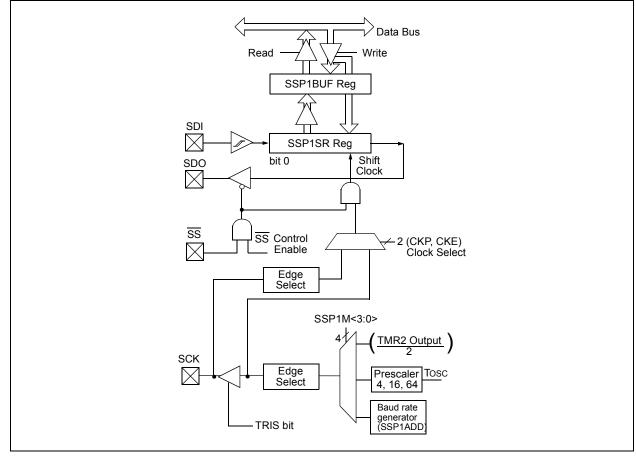
- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I<sup>2</sup>C<sup>™</sup>)

The SPI interface supports the following modes and features:

- Master mode
- Slave mode
- Clock Parity
- Slave Select Synchronization (Slave mode only)
- · Daisy-chain connection of slave devices

Figure 25-1 is a block diagram of the SPI interface module.





## 25.6.10 SLEEP OPERATION

While in Sleep mode, the I<sup>2</sup>C slave module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP1 interrupt is enabled).

## 25.6.11 EFFECTS OF A RESET

A Reset disables the MSSP1 module and terminates the current transfer.

## 25.6.12 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP1 module is disabled. Control of the I<sup>2</sup>C bus may be taken when the P bit of the SSP1STAT register is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed by hardware with the result placed in the BCL1IF bit.

The states where arbitration can be lost are:

- · Address Transfer
- Data Transfer
- · A Start Condition
- · A Repeated Start Condition
- An Acknowledge Condition

## 25.6.13 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin is '0', then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCL1IF, and reset the I<sup>2</sup>C port to its Idle state (Figure 25-32).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are deasserted and the SSP1BUF can be written to. When the user services the bus collision Interrupt Service Routine and if the  $l^2C$  bus is free, the user can resume communication by asserting a Start condition.

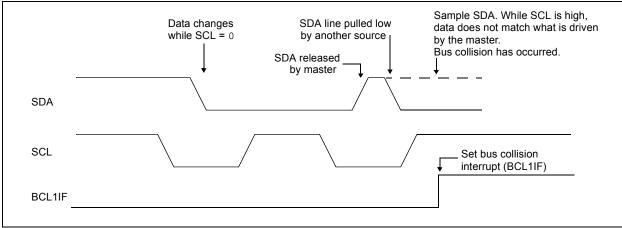
If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are deasserted and the respective control bits in the SSP1CON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the  $I^2C$  bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDA and SCL pins. If a Stop condition occurs, the SSP1IF bit will be set.

A write to the SSP1BUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the  $I^2C$  bus can be taken when the P bit is set in the SSP1STAT register, or the bus is Idle and the S and P bits are cleared.

## FIGURE 25-32: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE



## REGISTER 25-2: SSP1CON1: SSP1 CONTROL REGISTER 1

R/C/HS-0	)/0 R/C/HS-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
WCOL	SSP10V	SSP1EN	СКР		SSP1I	VI<3:0>	
bit 7		•	•	•			bit
Legend:							
R = Readab	le bit	W = Writable bi	t	U = Unimplemer	nted bit, read as '0	,	
u = Bit is un	changed	x = Bit is unkno	wn	-n/n = Value at F	OR and BOR/Valu	ue at all other Rese	ets
'1' = Bit is se	et	'0' = Bit is clear	ed	HS = Bit is set b	y hardware	C = User cleared	l
					,		
bit 7	Master mode:	ollision Detect bit	intor was attampt	ed while the I <sup>2</sup> C co	nditions were not a	colid for a transmiss	aion to bo start
	0 = No collisio <u>Slave mode:</u>	n BUF register is writt		ansmitting the previo			
bit 6		ive Overflow Indic	ator hit(1)				
	is lost. Óve data, to av initiated by 0 = No overflo <u>In I<sup>2</sup>C mode:</u> 1 = A byte is r	erflow can only occ oid setting overflow writing to the SSP w eceived while the st be cleared in so	ur in Slave mode. v. In Master mode 1BUF register (m SSP1BUF regist	ster is still holding th In Slave mode, the , the overflow bit is i ust be cleared in so er is still holding the	user must read the not set since each r ftware).	SSP1BUF, even if new reception (and	only transmittin transmission) is
bit 5		nronous Serial Po when enabled, the		properly configure	d as input or outpu	ıt	
	1 = Enables set 0 = Disables s $\frac{\ln l^2 C \mod e}{1}$ 1 = Enables th	erial port and con	figures these pin onfigures the SDA	and SCL pins as the			
bit 4	<ul> <li>0 = Disables serial port and configures these pins as I/O port pins</li> <li>CKP: Clock Polarity Select bit <ul> <li>In SPI mode:</li> <li>1 = Idle state for clock is a high level</li> <li>0 = Idle state for clock is a low level</li> <li>In I<sup>2</sup>C Slave mode:</li> <li>SCL release control</li> <li>1 = Enable clock</li> <li>0 = Holds clock low (clock stretch). (Used to ensure data setup time.)</li> <li>In I<sup>2</sup>C Master mode:</li> <li>Unused in this mode</li> </ul> </li> </ul>						
bit 3-0	0000 = SPI Ma; 0001 = SPI Ma; 0010 = SPI Ma; 0100 = SPI Ma; 0100 = SPI Sla 0101 = SPI Sla $0101 = I^2C Slav$ $1000 = I^2C Ma;$ 1001 = Reserve 1010 = SPI Ma; $1011 = I^2C firm$ 1100 = Reserve 1101 = Reserve $1101 = I^2C Slav$	ve mode, 7-bit ado ve mode, 10-bit ado ster mode, clock = ed ster mode, clock = ware controlled M ed ed ve mode, 7-bit ado	Fosc/4 Fosc/16 Fosc/64 TMR2 output/2 SCK pin, <u>SS</u> pin SCK pin, <u>SS</u> pin tress Idress Fosc / (4 * (SSF Fosc/(4 * (SSP aster mode (Slav	control enabled _ control disabled, S P1ADD+1)) <sup>(4)</sup> 1ADD+1))( <sup>5)</sup>	ts enabled	I/O pin	
Note 1:	In Master mode, the c			-	-	iated by writing to	the SSP1BUF
2: 3: 4: 5:	register. When enabled, these When enabled, the SI SSP1ADD values of 0 SSP1ADD value of '0'	pins must be prop DA and SCL pins i ), 1 or 2 are not su	perly configured a must be configure Ipported for I <sup>2</sup> C N	as input or output. ed as inputs. Aode.	.,	,, <u>.</u>	

## 28.0 IN-CIRCUIT SERIAL PROGRAMMING<sup>™</sup> (ICSP<sup>™</sup>)

ICSP<sup>™</sup> programming allows customers to manufacture circuit boards with unprogrammed devices. Programming can be done after the assembly process allowing the device to be programmed with the most recent firmware or a custom firmware. Five pins are needed for ICSP<sup>™</sup> programming:

- ICSPCLK
- ICSPDAT
- MCLR/VPP
- VDD
- Vss

In Program/Verify mode the program memory, user IDs and the Configuration Words are programmed through serial communications. The ICSPDAT pin is a bidirectional I/O used for transferring the serial data and the ICSPCLK pin is the clock input. For more information on ICSP<sup>TM</sup> refer to the "*PIC16F/LF182X/PIC12F/LF1822 Memory Programming Specification*" (DS41403).

## 28.1 High-Voltage Programming Entry Mode

The device is placed into High-Voltage Programming Entry mode by holding the ICSPCLK and ICSPDAT pins low then raising the voltage on MCLR/VPP to VIHH.

Some programmers produce VPP greater than VIHH (9.0V), an external circuit is required to limit the VPP voltage. See Figure 28-1 for example circuit.

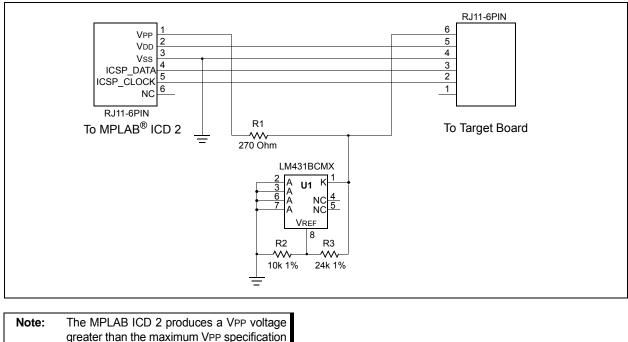


FIGURE 28-1: VPP LIMITER EXAMPLE CIRCUIT

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of the PIC12(L)F1822/16(L)F1823.

RETFIE	Return from Interrupt			
Syntax:	[label] RETFIE			
Operands:	None			
Operation:	$\begin{array}{l} TOS \to PC, \\ 1 \to GIE \end{array}$			
Status Affected:	None			
Description:	Return from Interrupt. Stack is POPed and Top-of-Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a 2-cycle instruction.			
Words:	1			
Cycles:	2			
Example:	RETFIE			
	After Interrupt PC = TOS GIE = 1			

RETURN	Return from Subroutine
Syntax:	[label] RETURN
Operands:	None
Operation:	$TOS \rightarrow PC$
Status Affected:	None
Description:	Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a 2-cycle instruction.

RETLW	Return with literal in W	RLF	Detete Left (through Comm
Syntax:	[ <i>label</i> ] RETLW k		Rotate Left f through Carry
Operands:	$0 \le k \le 255$	Syntax:	[ <i>label</i> ] RLF f,d
Operation:	$k \rightarrow (W);$ TOS $\rightarrow$ PC	Operands:	$0 \le f \le 127$ $d \in [0,1]$
Status Affected:	None	Operation:	See description below
Description:	The W register is loaded with the 8-bit	Status Affected:	С
	literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a 2-cycle instruction.	Description:	The contents of register 'f' are rotated one bit to the left through the Carry flag. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is
Words:	1		stored back in register 'f'.
Cycles:	2		C Register f
Example:	CALL TABLE;W contains table	Words:	1
	<pre>;offset value ,W now has table value</pre>	Cycles:	1
TABLE	•	Example:	RLF REG1,0
	•		Before Instruction
	ADDWF PC ;W = offset RETLW k1 ;Begin table		REG1 = 1110 0110
	REILW KI /Begin table REILW k2 ;		C = 0
	•		After Instruction
	•		REG1 = 1110 0110 W = 1100 1100
	•		M = 1100 1100 C = 1
	RETLW kn ; End of table		C – 1
	Before Instruction W = 0x07 After Instruction W = value of k8		

## 31.0 DC AND AC CHARACTERISTICS GRAPHS AND CHARTS

The graphs and tables provided in this section are for design guidance and are not tested.

In some graphs or tables, the data presented are **outside specified operating range** (i.e., outside specified VDD range). This is for **information only** and devices are ensured to operate properly only within the specified range.

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.

"Typical" represents the mean of the distribution at 25°C. "MAXIMUM", "Max.", "MINIMUM" or "Min." represents (mean +  $3\sigma$ ) or (mean -  $3\sigma$ ) respectively, where  $\sigma$  is a standard deviation, over each temperature range.

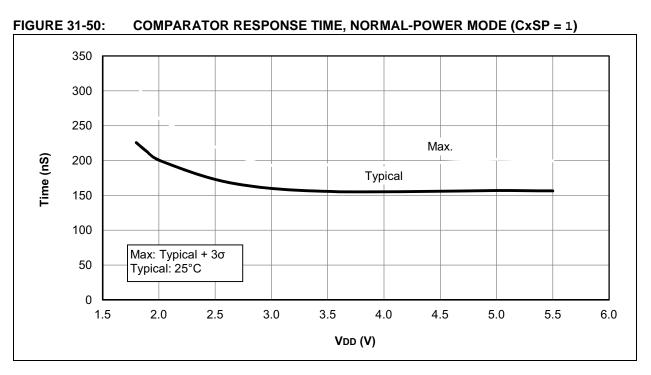
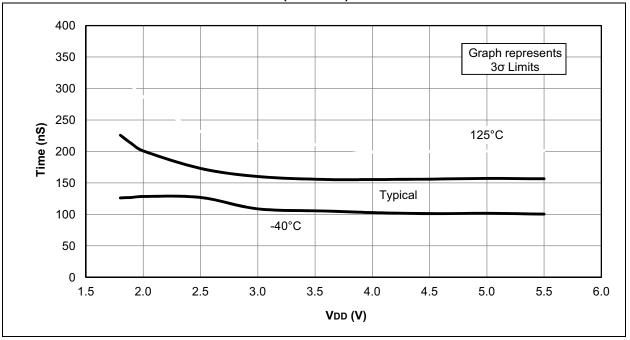


FIGURE 31-51: COMPARATOR RESPONSE TIME OVER TEMPERATURE, NORMAL-POWER MODE (CxSP = 1)



## 32.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM<sup>™</sup> and dsPICDEM<sup>™</sup> demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ<sup>®</sup> security ICs, CAN, IrDA<sup>®</sup>, PowerSmart battery management, SEEVAL<sup>®</sup> evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

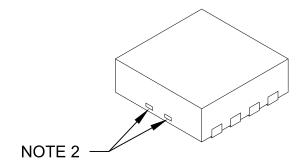
## 32.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent<sup>®</sup> and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika<sup>®</sup>

## 8-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			S
Dimension	MIN	NOM	MAX	
Number of Pins	N		8	
Pitch	е		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	-
Overall Length	D	3.00 BSC		
Exposed Pad Width	E2	1.34	-	1.60
Overall Width	E		3.00 BSC	
Exposed Pad Length	D2	1.60	-	2.40
Contact Width	b	0.25	0.30	0.35
Contact Length	L	0.20	0.30	0.55
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package may have one or more exposed tie bars at ends.

3. Package is saw singulated

4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-062C Sheet 2 of 2

## **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	[X]     -     X       I     I     I       Tape and Reel     Temperature	/XX Package	XXX   Pattern		amples:
Device: Tape and Reel Option:	OptionRangePIC12F1822, PIC12LF1822 PIC16F1823, PIC16LF1823Blank = standard packaging (tube T = Tape and Reel <sup>(1)</sup>	or tray)	Fattern	a) b) c)	PIC12F1822 - I/MF 301 = Industrial temp., DFN package, QTP pattern #301. PIC16F1823 - I/P = Industrial temp., PDIP package. PIC16F1823 - E/ST= Extended temp., TSSOP package.
Temperature Range:		dustrial) xtended)			
Package: <sup>(2)</sup> Pattern:	JQ = Micro Lead Frame (UQ MF = Micro Lead Frame (DF ML = Micro Lead Frame (QF P = Plastic DIP RF = Micro Lead Frame (UD SL = SOIC SN = SOIC ST = TSSOP QTP, SQTP, Code or Special Requ	N) 3x3x0.9mm N) 4x4x0.9mm FN) 3x3x0.5mm		Note	<ul> <li>catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.</li> <li>2: Small-form factor packaging options may be available. Please check www.microchip.com/packaging for small form-factor package availability, or contact</li> </ul>
	(blank otherwise)				your local Sales Office.